



WP9

Heat load review, Inner Triplet and D1 Heat loads

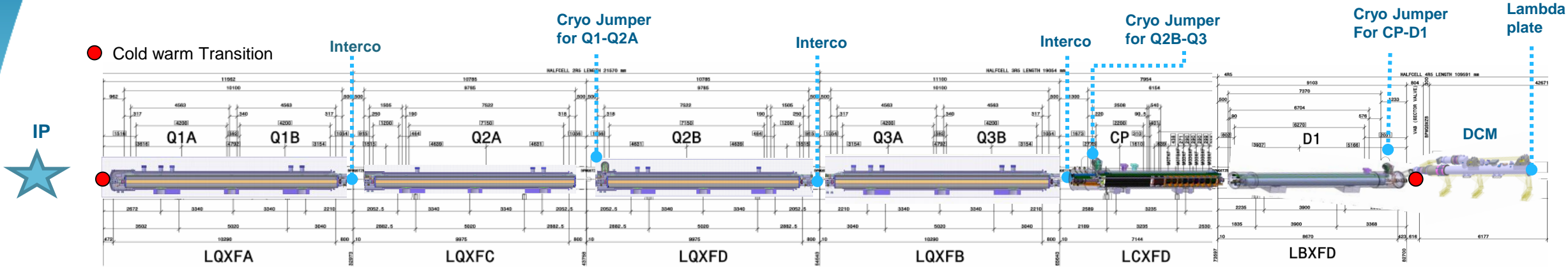
P. Zijm, V. Gahier and M. Sisti on behalf of WP9 and
H. Prin, D. Ramos, L. Williams, Y. Leclercq on behalf of WP3.

<https://indico.cern.ch/event/1019569/>
EDMS 2560550
CERN, 27/04/2021

Content

- Inner Triplet Mechanical configuration
- Inner Triplet cooling scheme
- Heat loads Mechanisms
- Static Heat loads
- Dynamic Heat loads
- Design Heat loads
- Evolution
- KPI Benchmark
- Conclusions

Inner Triplet Mechanical configuration

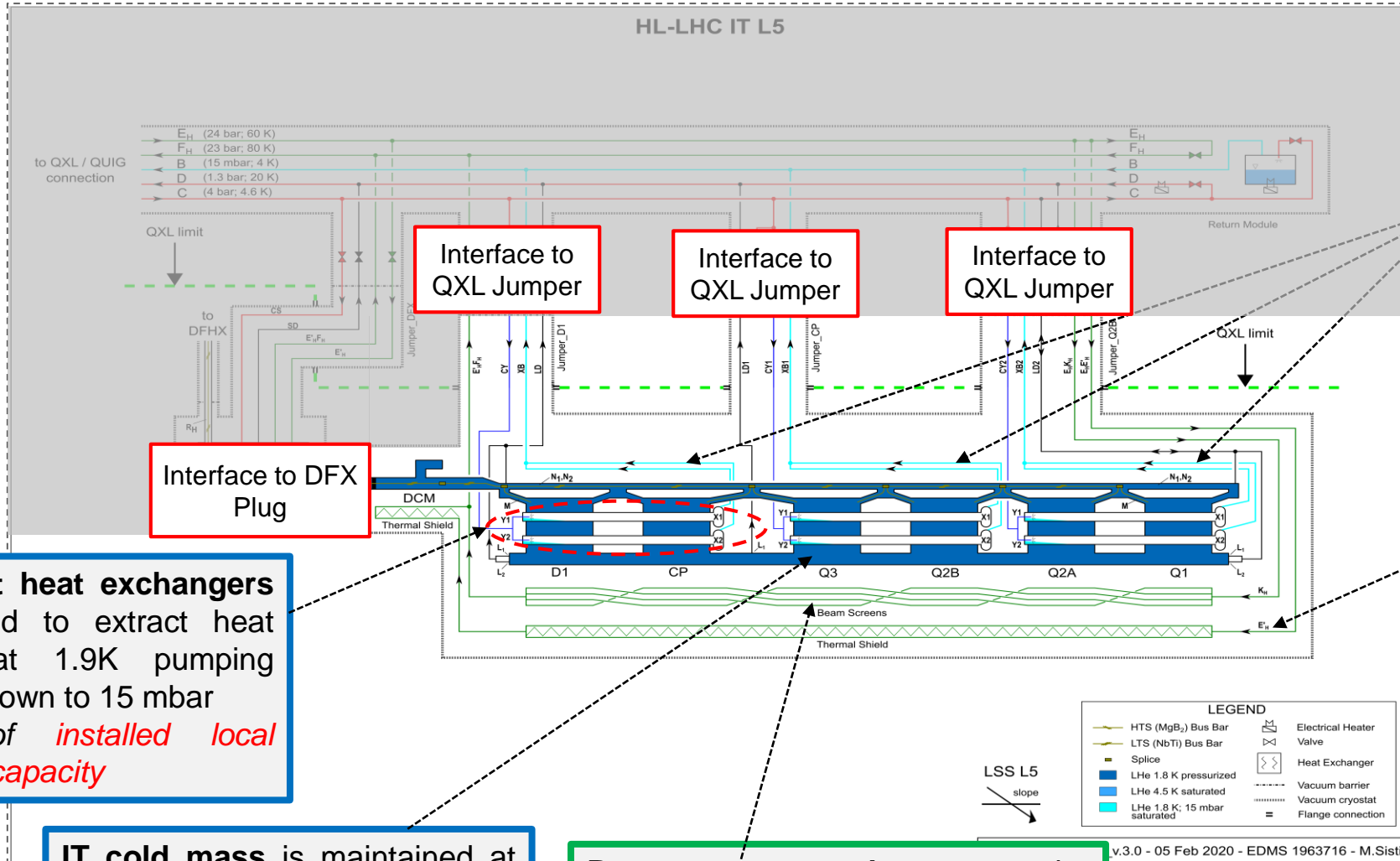


	Q1	Q2A	Q2B	Q3	CP	D1	DCM
	Aperture: 150 mm NbSn3 Coated SEY @ 1.1	Aperture: 150 mm NbSn3 Coated SEY @ 1.1*	Aperture: 150 mm NbSn3 Coated SEY @ 1.1	Aperture: 150 mm NbSn3 Coated SEY @ 1.1	NbTi Coated SEY @ 1.1	NbTi Coated SEY @ 1.1	NbTi splices in He II bath
Cryostat length	11.56 m	10.78 m	10.78 m	11.10 m	7.95 m	9.1 m	6.17 m
Heat loads on the cold mass at 1.9 K	Static	++	+	+	++	+	+ (plug to SC link)
	Resistive	+/2	+/4	+/4	+/2	+/4	+/4
	Beam induced	Reduced by coating	Reduced by coating	Reduced by coating	Reduced by coating	Reduced by coating	None
	Collision induced	+++++	+++++	+++++	+++++	+++++	Negligible

+ = 20 W (approximately)

* Plug in module not coated; SEY 1.3 (RF Fingers)

Inner Triplet + D1 cooling scheme



3 coolings loops
 → one for each magnet pair
 Linked to the cryo-distribution through 3 service modules

Thermal shield loop at 60-80 K to limit the heat loads at 1.9 K
 Reduction of the heat loads to 1.9K of 90%.

Bayonet heat exchangers are used to extract heat loads at 1.9K pumping helium down to 15 mbar
Limit of installed local cooling capacity

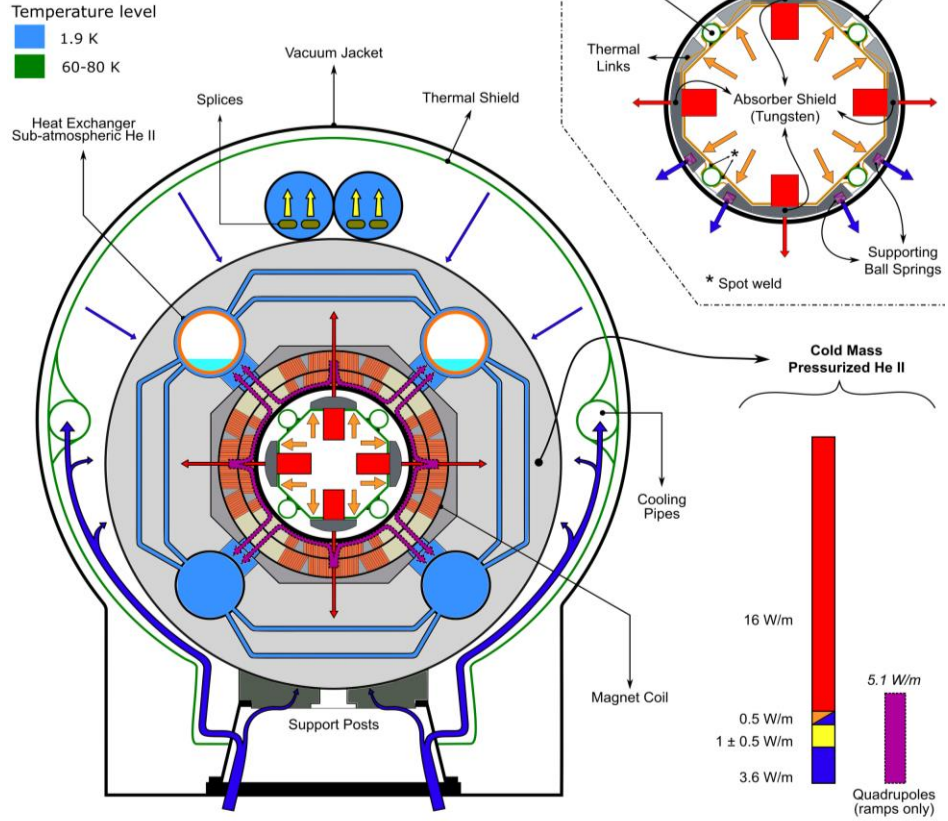
IT cold mass is maintained at **1.9 K** in a **common He-II bath** at 1.3 bar allowing to balance cooling loop capacity.

Beam screen loop to be maintained above **60 K** and below **80 K** to avoid cryo pumping and vacuum degassing at cold bore.

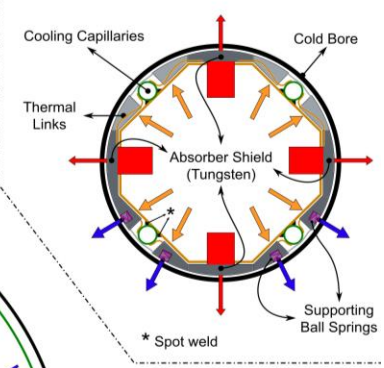
v.3.0 - 05 Feb 2020 - EDMS 1963716 - M.Sisti

Heat loads Mechanisms on a Quadrupole Magnet

HEAT LOADS DEPOSITION HL-LHC IT CROSS-SECTION

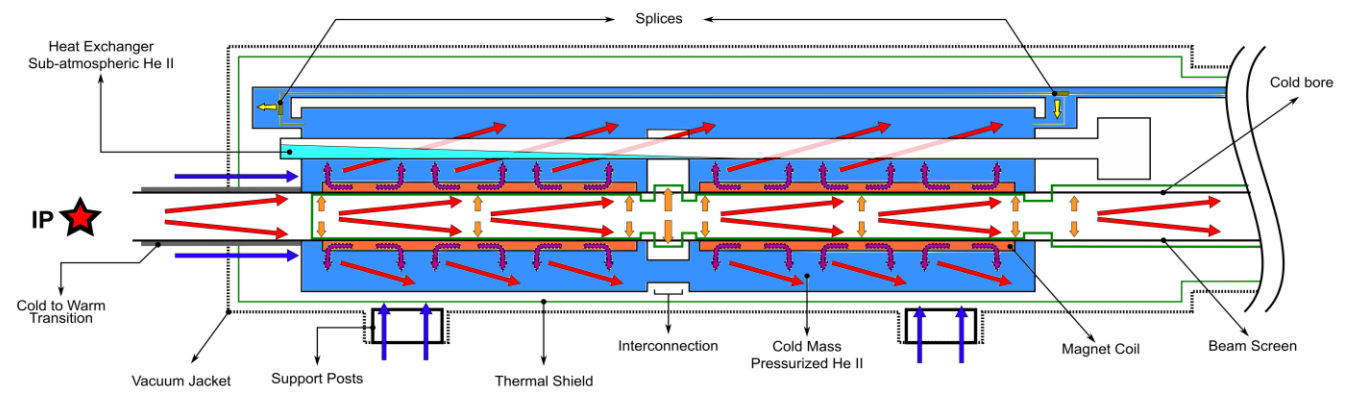


BEAM SCREEN DETAILS

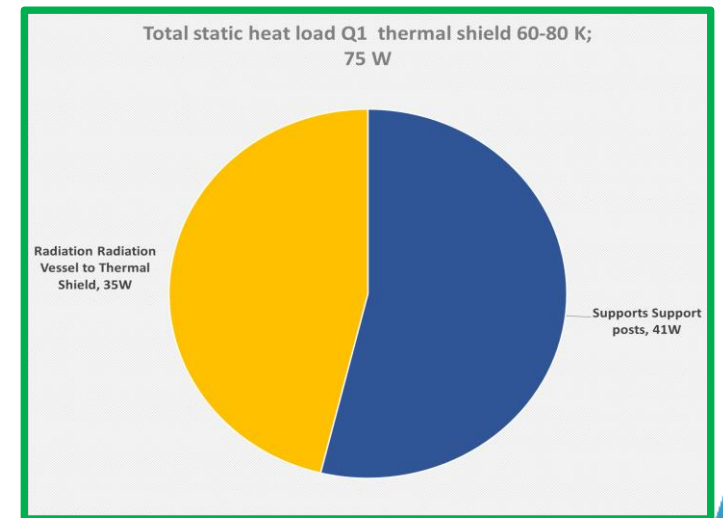
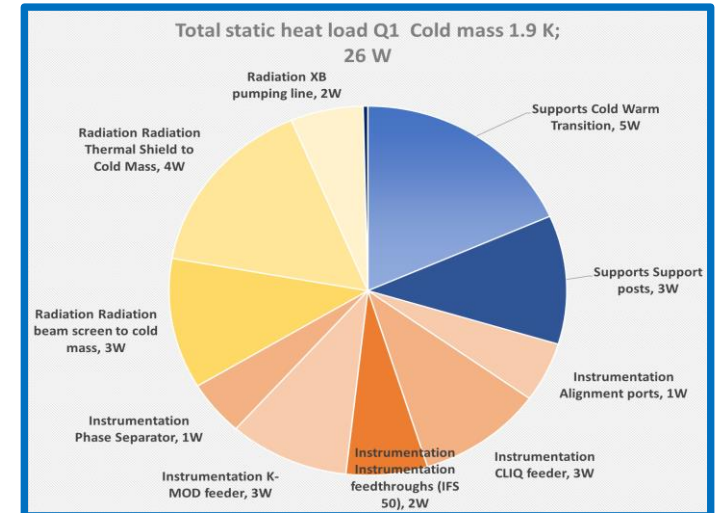
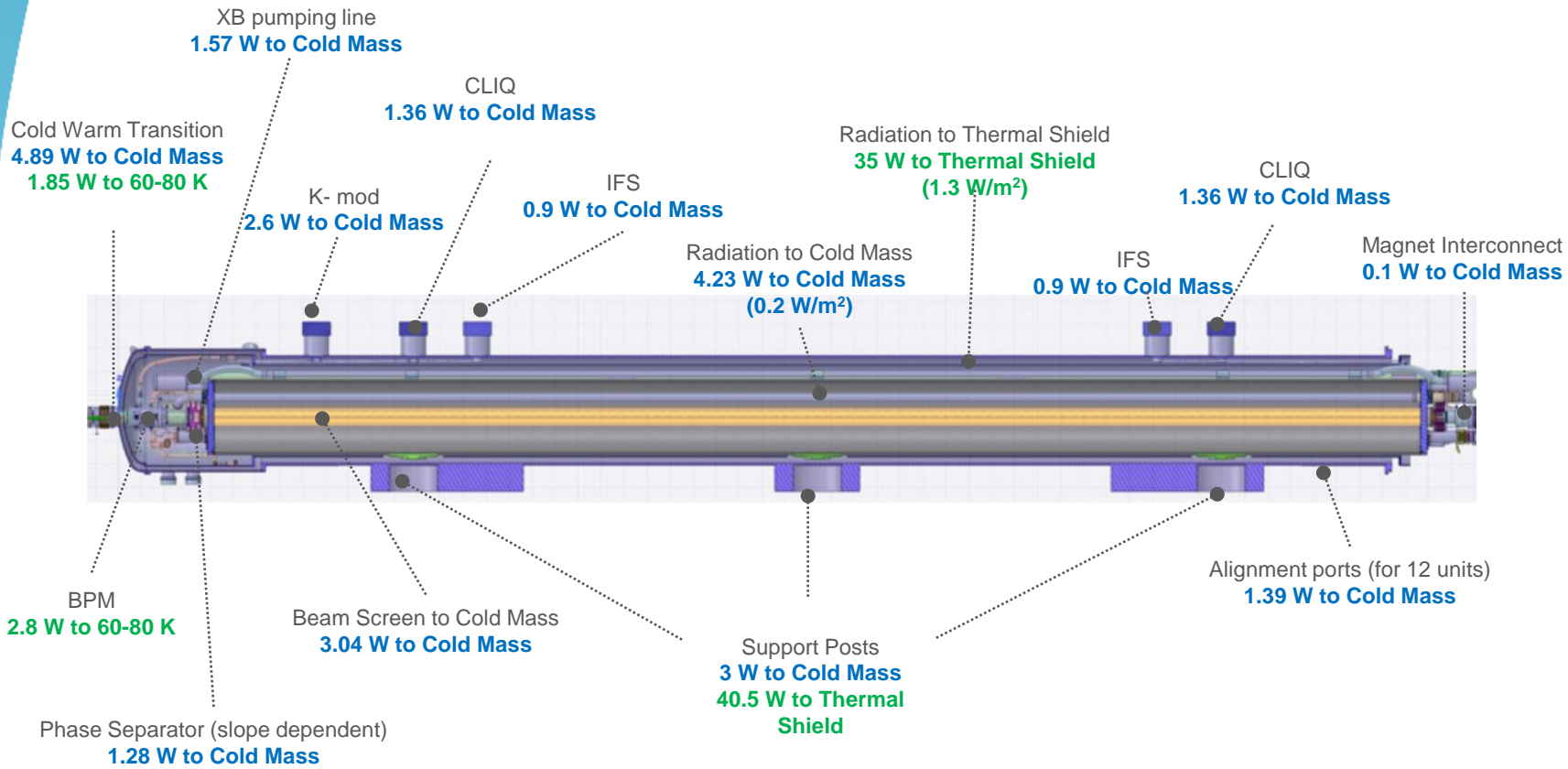


HEAT LOADS DEPOSITION HL-LHC IT SIDE-VIEW

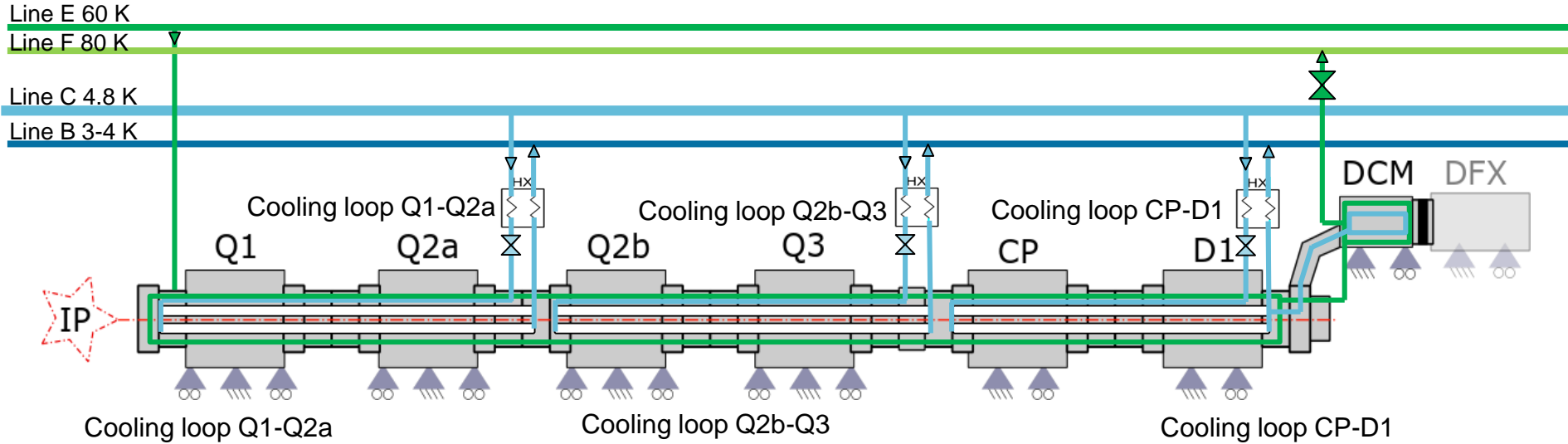
TE-MSC	TE-MSC	TE-MSC	BE-ABP	SY-STI
STATIC LOADS	RESISTIVE LOADS	MAGNETIC LOADS	BEAM INDUCED LOADS	COLLISION INDUCED LOADS
<ul style="list-style-type: none"> - Support posts - CWT - Beam Screen supports - BPM cables - IFS, K-mod, CLIQ - Conduction - Radiation - Alignment port - Magnet interconnect - Phase separator 	<ul style="list-style-type: none"> - NbTi-Nb₃Sn Splices 	<ul style="list-style-type: none"> - A.C. losses - Constant current → 0 W (Ramp-up, Ramp-down) 	<ul style="list-style-type: none"> - Synchrotron radiation - Image current (induction) - Beam scattering - Photo-electron cloud 	<ul style="list-style-type: none"> - Secondary particle losses
DEPOSITION LEVEL	DEPOSITION LEVEL	DEPOSITION LEVEL	DEPOSITION LEVEL	DEPOSITION LEVEL
Cold Mass Beam Screen Thermal Shield	Cold Mass	Cold Mass	Cold Mass Beam Screen	Cold Mass Beam Screen



Example of Q1 – Static heat loads Identification



Static heat loads – Sources identification



Cooling loop Q1-Q2a		Cooling loop Q2b-Q3		Cooling loop CP-D1		DCM
Q1	Q2a	Q2b	Q3	CP	D1	DCM
<ul style="list-style-type: none"> • Support posts • CWT long • K-mod • CLIQ • IFS 402 • Phase Separator* • Alignment ports • Thermal Shield • Beam Screen • Interconnect • XB pumping line 	<ul style="list-style-type: none"> • Support posts • CLIQ • IFS 280/402 • Phase Separator* • Alignment ports • Thermal Shield • Beam Screen • Interconnect • XB pumping line 	<ul style="list-style-type: none"> • Support posts • CLIQ • IFS 402/280 • Phase Separator* • Alignment ports • Thermal Shield • Beam Screen • Interconnect • XB pumping line 	<ul style="list-style-type: none"> • Support posts • K-mod • CLIQ • IFS 402 • Phase Separator* • Alignment ports • Thermal Shield • Beam Screen • Interconnect • XB pumping line 	<ul style="list-style-type: none"> • Support posts • IFS 402/280 • Phase Separator* • Thermal Shield • Beam Screen • Current leads • Interconnect • Beam pumping line** • XB pumping line 	<ul style="list-style-type: none"> • Support posts • IFS 280 • CWT long • Phase Separator* • Thermal Shield • Beam Screen • Interconnect • XB pumping line 	<ul style="list-style-type: none"> • Vacuum barrier • Thermal Shield • Lambda plate • IFS 280

Q1/Q2a/Q2b/Q3/CP/D1/DCM

<ul style="list-style-type: none"> • CWT/BPM • Radiation • Support posts 	<ul style="list-style-type: none"> • BPM • Radiation • Support posts 	<ul style="list-style-type: none"> • BPM • Radiation • Support posts 	<ul style="list-style-type: none"> • BPM • Radiation • Support posts 	<ul style="list-style-type: none"> • BPM • Radiation • Support posts • Current leads 	<ul style="list-style-type: none"> • CWT/BPM • Radiation • Support posts 	<ul style="list-style-type: none"> • Radiation • Support
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*Phase separator location is slope dependent (2 per magnet pair)

** Negligible

Static heat loads – Systematic ID card created for each element

Example for K-mod

K-mod																																	
Type	K-mod																																
Function	Used for modulating of the quadrupole gradients.																																
Number of items	2 (4 feeders, 2 per K-mod)																																
CONTACT																																	
Name(s)	L. Williams / T. Koettig																																
Department	BE-BI-ML / TE-CRG																																
Latest Reference	HL-LHC K-mod current feeders Cryolab thermal performance test																																
EDMS	2279955																																
Version	3																																
Date	28-Sep-20																																
PROPERTIES			SCHEMATIC																														
Property	Value	Unit																															
Conductor cross section		10 mm ²																															
Number of wires		2 -																															
Length of conductor		2 m																															
Temperatures																																	
Operating temperature		1.9 K																															
Warm		300 K																															
Intercept		- K																															
<i>No intercept implemented</i>																																	
Powering																																	
Current		25 A																															
HEAT LOAD components																																	
Data	Value	Unit	Items																														
Conduction to 1.9 K		1.2 W	4																														
Resistive load at 1.9 K		0.1 W	4	<table border="1"> <thead> <tr> <th>MAGNET</th> <th>K-mod/ CLIQ</th> <th>Drawing Nr.</th> </tr> </thead> <tbody> <tr> <td>Q1A</td> <td>K-mod</td> <td>LHCQQXF_DQ0077</td> </tr> <tr> <td>Q1A</td> <td>CLIQ</td> <td>LHCQQXF_DQ0044</td> </tr> <tr> <td>Q1B</td> <td>CLIQ</td> <td>LHCQQXF_DQ0044</td> </tr> <tr> <td>Q2A</td> <td>CLIQ</td> <td>LHCQQXF_DQ0044</td> </tr> <tr> <td>Q2B</td> <td>CLIQ</td> <td>LHCQQXF_DQ0044</td> </tr> <tr> <td>Q3A</td> <td>K-mod</td> <td>LHCQQXF_DQ0077</td> </tr> <tr> <td>Q3A</td> <td>CLIQ</td> <td>LHCQQXF_DQ0044</td> </tr> <tr> <td>Q3B</td> <td>CLIQ</td> <td>LHCQQXF_DQ0044</td> </tr> </tbody> </table>			MAGNET	K-mod/ CLIQ	Drawing Nr.	Q1A	K-mod	LHCQQXF_DQ0077	Q1A	CLIQ	LHCQQXF_DQ0044	Q1B	CLIQ	LHCQQXF_DQ0044	Q2A	CLIQ	LHCQQXF_DQ0044	Q2B	CLIQ	LHCQQXF_DQ0044	Q3A	K-mod	LHCQQXF_DQ0077	Q3A	CLIQ	LHCQQXF_DQ0044	Q3B	CLIQ	LHCQQXF_DQ0044
MAGNET	K-mod/ CLIQ	Drawing Nr.																															
Q1A	K-mod	LHCQQXF_DQ0077																															
Q1A	CLIQ	LHCQQXF_DQ0044																															
Q1B	CLIQ	LHCQQXF_DQ0044																															
Q2A	CLIQ	LHCQQXF_DQ0044																															
Q2B	CLIQ	LHCQQXF_DQ0044																															
Q3A	K-mod	LHCQQXF_DQ0077																															
Q3A	CLIQ	LHCQQXF_DQ0044																															
Q3B	CLIQ	LHCQQXF_DQ0044																															
Heat Load Data per Unit																																	
Heat load 1.9 K	Value	Unit	Data type	Comment	Heat Load	Applicable																											
Static		1.2 W	Measurement	Per K-mod	Static	yes																											
Resistive		0.1 W	Measurement	Per K-mod	Resistive	yes																											
Total		1.3 W	Measurement	Per K-mod	Magnetic	-																											
					Beam Induced	-																											
					Collision Induced	-																											

Summary of data (temperature, material, dimensions)

Contact person/department describing the references for data

Schematic and layout

Summary of heat loads

All available in EDMS : <https://edms.cern.ch/document/2560668/0.0>

Static heat loads – Systematic ID card created for each element

Example for Magnet interconnect

- Hilumi magnet interconnect temperature is at 60-80 K.
- **Particularity for Hilumi**
- 5 magnet interconnect result in ~21 W heat load to 1.9 K

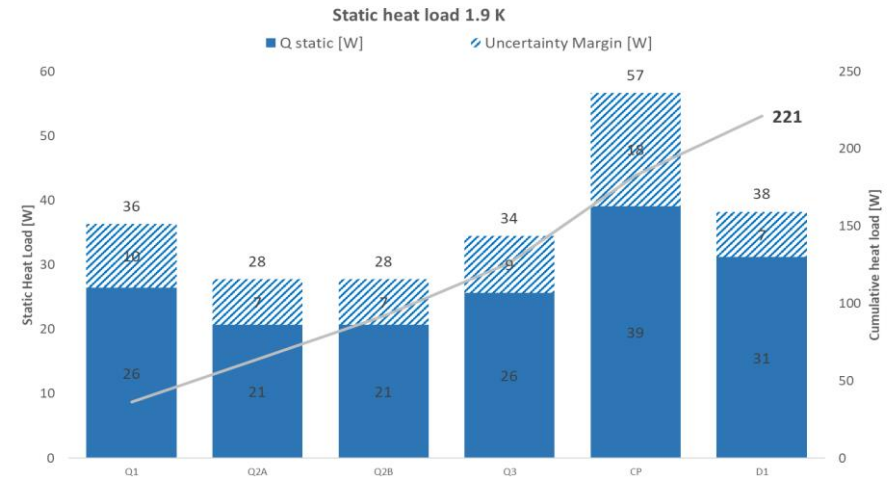
Magnet Interconnect short;						
Type	HL LHC short magnet interconnect					
Function	Connection between magnets					
Number of items	4					
CONTACT						
Name(s)	C. Garion					
Department	TE-VSC					
Latest Reference	-					
EDMS	-					
Version	-					
Date	-					
PROPERTIES				SCHEMATIC		
Property	Value	Unit	Comment			
Temperatures						
Operating Temperature		- K				
Temperature Intercept	60-80 K		Beam Screen			
Temperature Cold	1.9 K		Cold bore			
HEAT LOAD components				LAYOUT		
1.9 K	Value	Unit	Comment			
Supported side Conduction		4.1 W				
Bellow side conduction		0.1 W				
Heat Load Data						
Heat load 1.9 K	Value	Unit	Data type	Comment	Heat Load	Applicable
Static		4.2 W	ANSYS FEA	Per interconnect	Static	yes
					Resistive	-
					Magnetic	-
					Beam Induced	-
					Collision Induced	-

All available in EDMS : <https://edms.cern.ch/document/2560668/0.0>

Static heat loads on 1.9 K in Watt – Summary for one IT+D1

Cold Mass	Uncertainty factor	Q1		Q2a		Q2b		Q3		CP		D1		DCM		Grand total	
		Q_{static}	$F_{un} * Q_{static}$	Q_{static}	$F_{un} * Q_{static}$	Q_{static}	$F_{un} * Q_{static}$	Q_{static}	$F_{un} * Q_{static}$	Q_{static}	$F_{un} * Q_{static}$	Q_{static}	$F_{un} * Q_{static}$	Q_{static}	$F_{un} * Q_{static}$	Q_{static}	$F_{un} * Q_{static}$
Support posts	1.25	3.00	3.75	3.00	3.75	3.00	3.75	3.00	3.75	2.00	2.50	2.00	2.50	-	-	16.00	20.00
Vacuum barrier	1.50	-	-	-	-	-	-	-	-	-	-	-	-	5.00	7.50	5.00	7.50
Radiation Thermal Shield to Cold Mass	1.25	4.23	5.29	4.02	5.03	4.02	5.03	4.16	5.20	2.47	3.09	3.03	3.79			21.93	27.41
Radiation beam screen to cold mass	1.25	3.04	3.80	2.94	3.68	2.94	3.68	3.04	3.80	1.22	1.53	2.21	2.76			15.39	19.24
CWT / Interconnect	1.50	4.89	7.34	4.14	6.21	4.14	6.21	4.14	6.21	4.14	6.21	4.35	6.53			25.80	38.70
IFS type 1	2.00	1.76	3.52	0.88	1.76	0.88	1.76	1.76	3.52	0.88	1.76	-	-			6.16	12.32
IFS type 2	2.00	-	-	0.16	0.32	0.16	0.32	-	-	-	-	0.16	0.32			0.48	0.96
K-MOD	1.25	2.60	3.25	-	-	-	-	2.60	3.25	-	-	-	-			5.20	6.50
CLIQ	1.25	2.72	3.40	1.36	1.70	1.36	1.70	2.72	3.40	-	-	-	-			8.16	10.20
Phase Separator	1.00	1.28	1.28	1.28	1.28	1.28	1.28	1.28	1.28	1.28	1.28	1.28	1.28			7.68	7.68
Alignment ports	1.50	1.39	2.09	1.39	2.09	1.39	2.09	1.39	2.09	-	-	-	-			5.56	8.34
Lambda Plate	1.00	-	-	-	-	-	-	-	-	-	-	-	-	11.60	11.60	11.60	11.60
XB Pumping line	1.25	1.57	1.97	1.57	1.97	1.57	1.97	1.57	1.97	1.57	1.97	1.57	1.97	-	-	9.45	11.81
Local powering current leads	1.50	-	-	-	-	-	-	-	-	25.56	38.34	-	-			25.56	38.34
Total	-	26.48	35.68	20.74	27.77	20.74	27.77	25.66	34.46	39.12	56.67	14.60	19.14	16.60	19.10	163.97	220.60
Uncertainty factor	-	1.35		1.34		1.34		1.34		1.45		1.31		1.15		1.35	

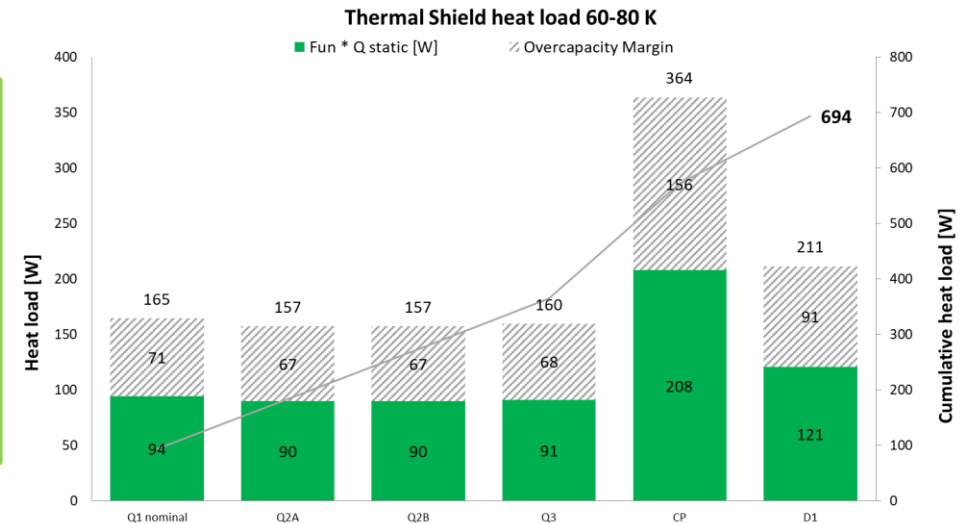
- Uncertainty factor (F_{un}) is tailored made for each users according to the uncertainty /room to growth left for each component (refer to Methodology talk for choice of coefficient)
 - This table does **not** include the overcapacity factor (F_{ov}) that is still to be included in design heat load
- **Uncertainty factor (F_{un}) decreased with the evolution to detailed design**



Static heat loads on Thermal shield (60-80 K) in Watt – Summary for one IT+D1

Thermal Shield 60-80 K	Uncertainty factor	Q1		Q2a		Q2b		Q3		CP		D1		DCM		Grand total	
		Q _{static}	F _{un} * Q _{static}	Q _{static}	F _{un} * Q _{static}	Q _{static}	F _{un} * Q _{static}	Q _{static}	F _{un} * Q _{static}	Q _{static}	F _{un} * Q _{static}	Q _{static}	F _{un} * Q _{static}	Q _{static}	F _{un} * Q _{static}	Q _{static}	F _{un} * Q _{static}
		Support posts	1.25	40.50	50.63	40.50	50.63	40.50	50.63	40.50	50.63	27.00	33.75	27.00	33.75	-	-
Vacuum barrier	1.50													30.00	45.00	30.00	45.00
Radiation to Thermal Shield	1.25	34.74	43.43	31.37	39.21	31.37	39.21	32.51	40.64	19.29	24.11	23.60	29.50	10.00	12.50	182.88	228.60
Current leads (conduction)	1.50	-	-	-	-	-	-	-	-	100.00	150.00	-	-	-	-	100.00	150.00
Total	-	75.24	94.05	71.87	89.84	71.87	89.84	73.01	91.26	146.29	207.86	50.60	63.25	40.00	57.50	528.88	693.60
Uncertainty factor	-	1.25		1.25		1.25		1.25		1.42		1.25		1.44		1.31	

- Values correspond to heat applied
- Uncertainty factor (F_{un}) is tailor made for each users according to the uncertainty /room to growth left for each component (refer to Methodology talk for choice of coefficient)
- This table does **not** include the overcapacity factor (F_{ov}) that is still to be included in design heat load
- **Uncertainty factor decreased with the evolution to detailed design**



Dynamic heat loads on 1.9 K & 60-80 K

Summary for one IT+D1

Refer to Beam induced heat loads by G. Iadarola (WP2) and Collisions induced Heat loads by M. Sabate Gilarte (WP10) for more details
Collision induced values from vertical crossing (global worst case)

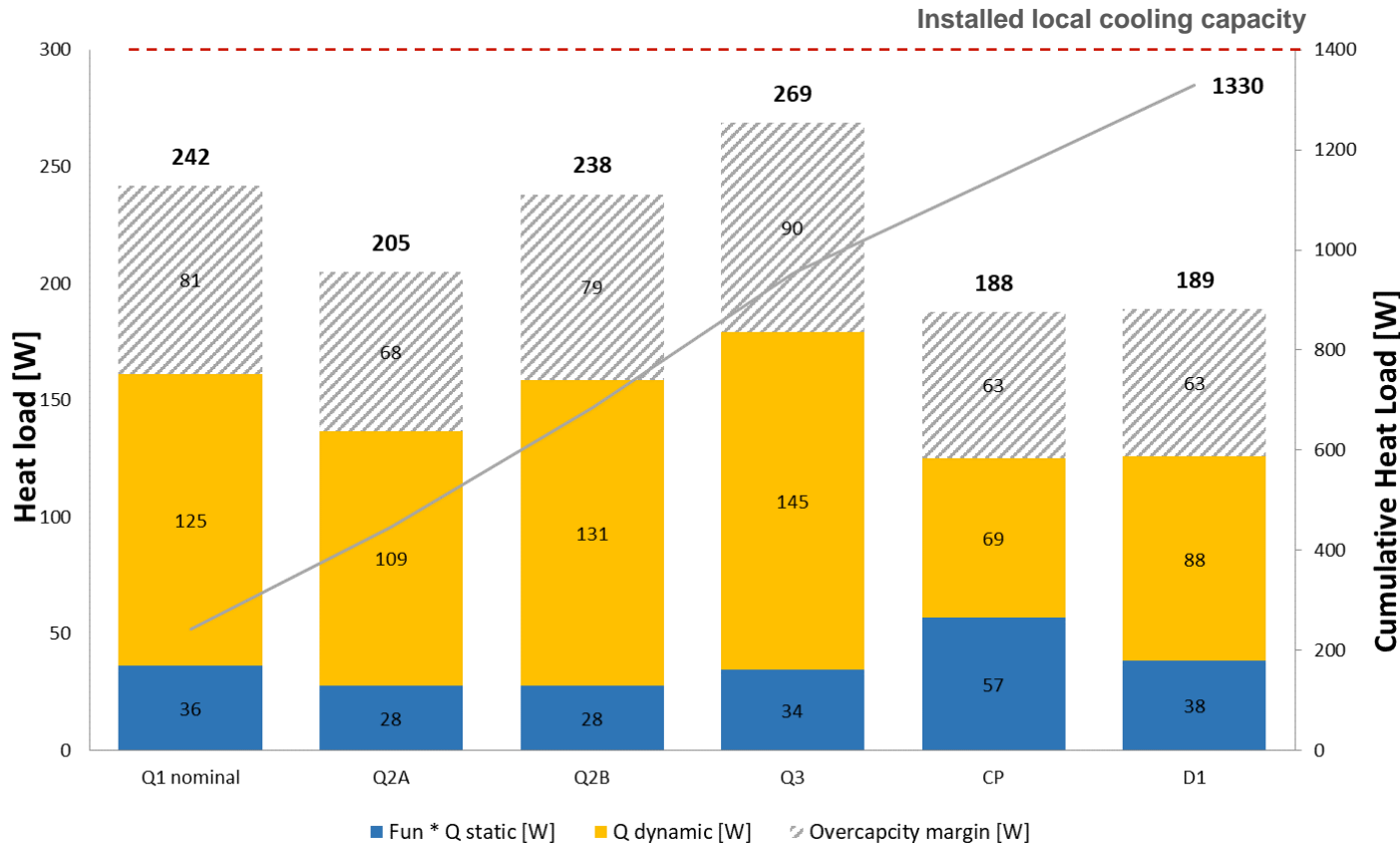
- Overcapacity on Nominal (5Lo / 7 TeV) dynamic heat loads is taken at 1.5;
- Ultimate conditions (7.5 Lo/ 7.5 TeV) are not designing;
- Beam induced heat loads at 1.9 K conservative estimate; no additional margin

		Q1	Q2a	Q2b	Q3	CP	D1	DCM	Grand total	
Cold Mass	Overcapacity factor	Q _{dynamic}	Q _{dynamic}	Q _{dynamic}	Q _{dynamic}	Q _{dynamic}	Q _{dynamic}	Q _{dynamic}	Q _{dynamic}	F _{ov} * Q _{dynamic}
	Resistive	1.50	7.00	4.00	4.00	7.00	0.00	1.00	2.30	25.30
Beam Induced	1.00	1.00	0.50	0.75	0.75	0.32	0.20	-	3.51	3.51
Collision Induced	1.50	116.89	104.22	126.22	136.89	68.22	84.22	-	636.67	955.00
Total	-	124.89	108.72	130.97	144.64	68.54	85.42	2.30	665.48	996.46

		Q1	Q2a	Q2b	Q3	CP	D1	DCM	Grand total	
Beam Screen 60-80 K	Overcapacity factor	Q _{dynamic}	Q _{dynamic}	Q _{dynamic}	Q _{dynamic}	Q _{dynamic}	Q _{dynamic}	Q _{dynamic}	Q _{dynamic}	F _{ov} * Q _{dynamic}
	Beam Induced	1.50	75.70	58.12	73.82	80.12	25.22	37.22	-	350.20
Collision Induced	1.50	193.00	85.67	105.00	97.67	73.67	75.00	-	630.00	945.00
Total	-	268.70	143.79	178.82	177.79	98.89	112.22	0.00	980.20	1470.30

Design heat loads for one IT + D1 @ 1.9 K

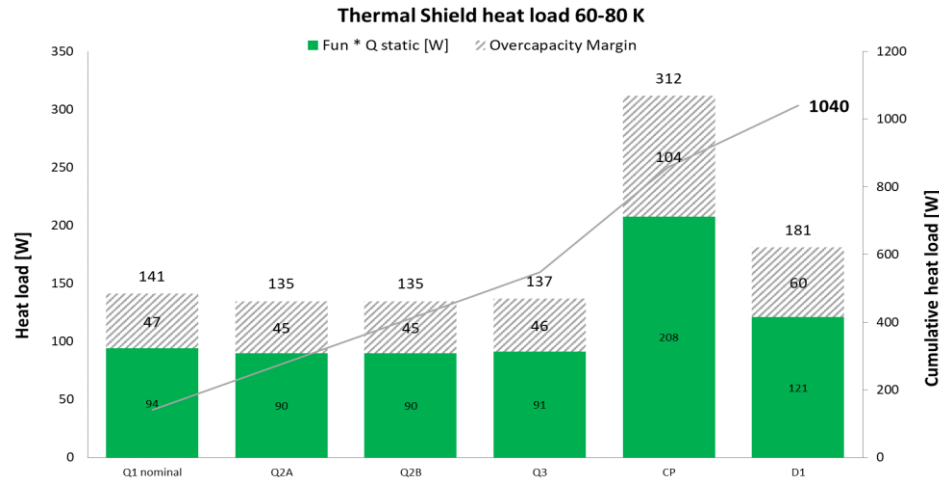
Design heat load IT+D1 1.9 K



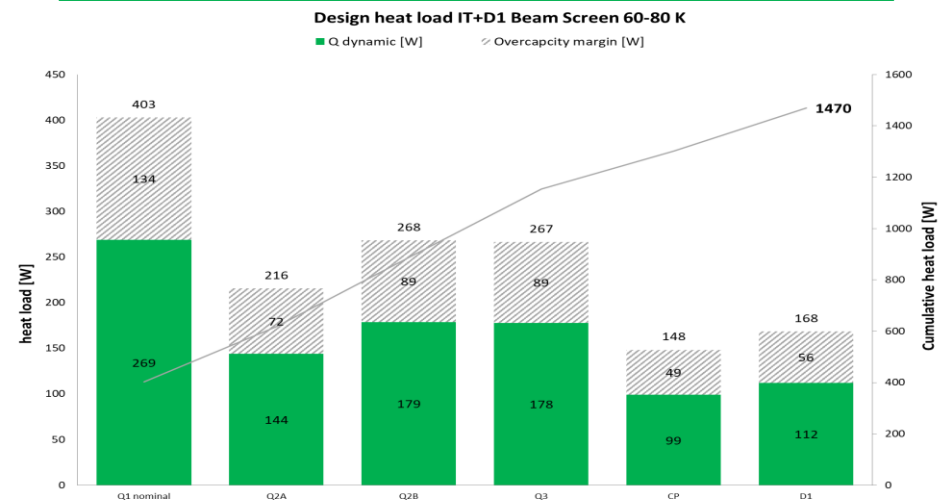
- *Local cooling capacity for one IT+ D1 is 1330 W at 1.9 K*
- *Dynamic heat loads account for ~ 75%*
- **Installed local cooling capacity (fixed limit of capacity)**
 - Bayonet heat exchangers in Inner triplet + D1 designed for **1400 W** in total

Design dynamic heat loads for one IT + D1 @ 60-80K

Thermal Shield heat load at 60-80 K



Beam screen heat load at 60-80 K



- *Thermal shield design heat loads for one IT+D1 is at ~1000 W*
- *Beam screen data provided by WP2 (beam induced) / WP10 (collisions)*
- *Beam screen design heat loads for one IT is taken at ~1500 W*
- *Total design for 60-80 K ~2500 W*

Hilumi KPI benchmark (for information)

		LHC arc*	LHC IT
Cold mass 1.9 K	Static	0.17 W/m	1.25 W/m
	Dynamic	0.45 -0.6 W/m	7.4 W/m
	Installed	0.9 W/m	10 W/m***
Beam screen 4.5 -20 K	Static	0.14 W/m	0.13 W/m
	Dynamic	1.7 W/m**	2.4 W/m
	Installed	2.4W/m/aperture	-
Thermal Shield 50-75 K	Static	4.5 W/m	-

		HL-LHC IT + D1
Cold mass 1.9 K	$F_{un} \times Q_{static}$	3.6 W/m
	Q_{design}	21.2 W/m
	Installed*	22.8 W/m
Beam screen 60-80 K	Q_{design}	21.2 W/m
Thermal Shield 60-80 K	$F_{un} \times Q_{static}$	11.2 W/m
	Q_{design}	16.8 W/m

* Static are without contingencies from Design report

** Nominal case is indicated

*** For 500W bayonet exchanger initially installed- was changed to 300 W

* Considering installed local capacity at 1400 W for HL-LHC

- Static heat loads were highly optimized for LHC due to the overall length to be considered;
- Contribution on 1.9 K is consequently higher on HL-LHC due to the Luminosity

Evolution of heat loads 2016 – 2020 – 2021 for one IT+D1

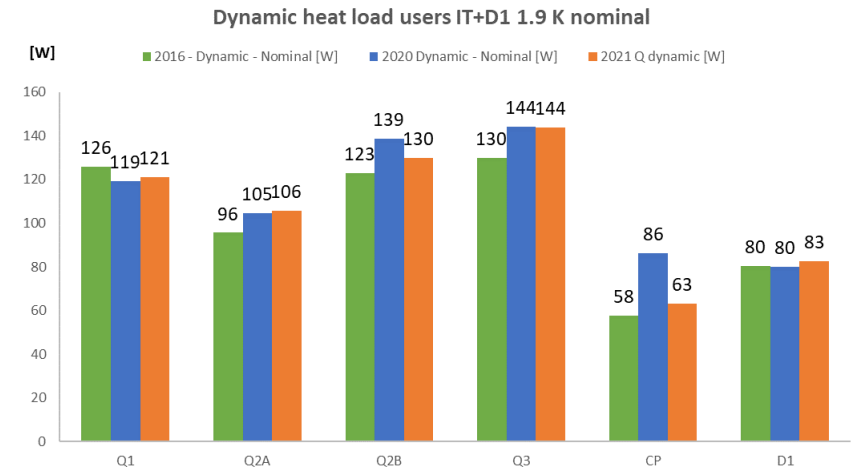
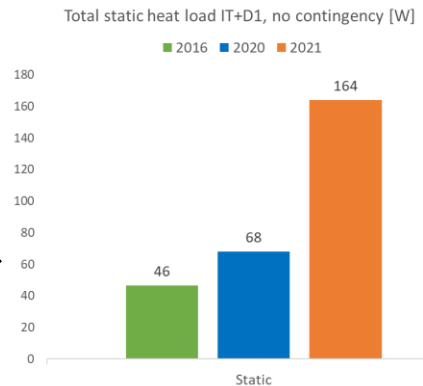
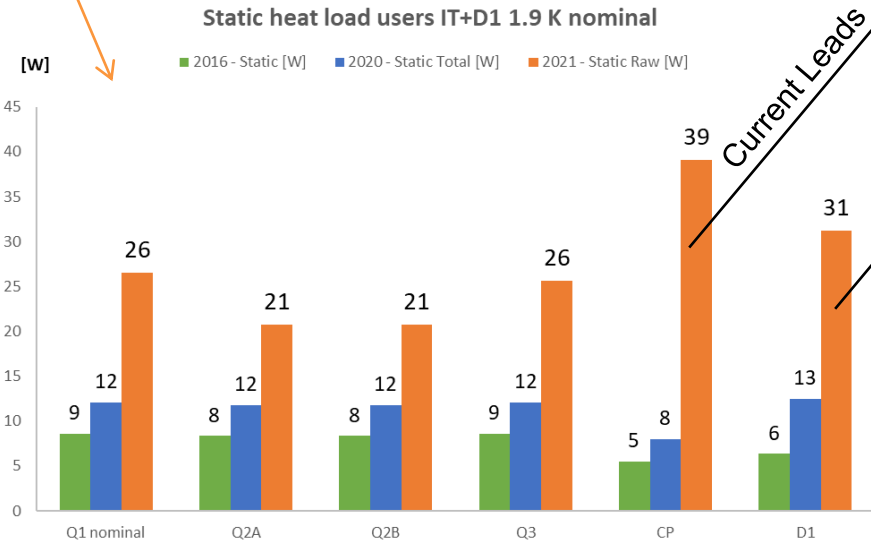
- Evolution of heat loads due to maturing design as well as addition of new components
 - Static heat loads increased significantly
 - Dynamic heat loads relatively stable

~4 W per magnet due to Interco at 60-80 K. (21 W total)

Increase due to change of design of the local powering 26 W : Current leads

Addition of cold diode module 17 W : DCM

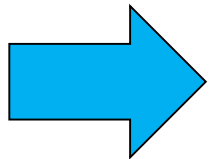
Main additions to static heat loads
 60-80 K Magnet interconnect
 60-80 K Thermal shield radiation
 Local powering current leads
 DCM module
 XB pumping line



Conclusions

- Detailed evaluation of heat loads
 - ID cards to validate configuration and heat loads
- Revised baseline
 - latest configuration and estimates.
- Review of the heat loads
 - Confirmation nothing puts future performance at risk.
- **The total design heat load at 1.9 K is very close to the limit of the installed local cooling capacity.**

All parties involved shall be aware of the situation



It is time to freeze the configuration and commit on these figures considering fabrication and installation phases

Thanks for your time and attention

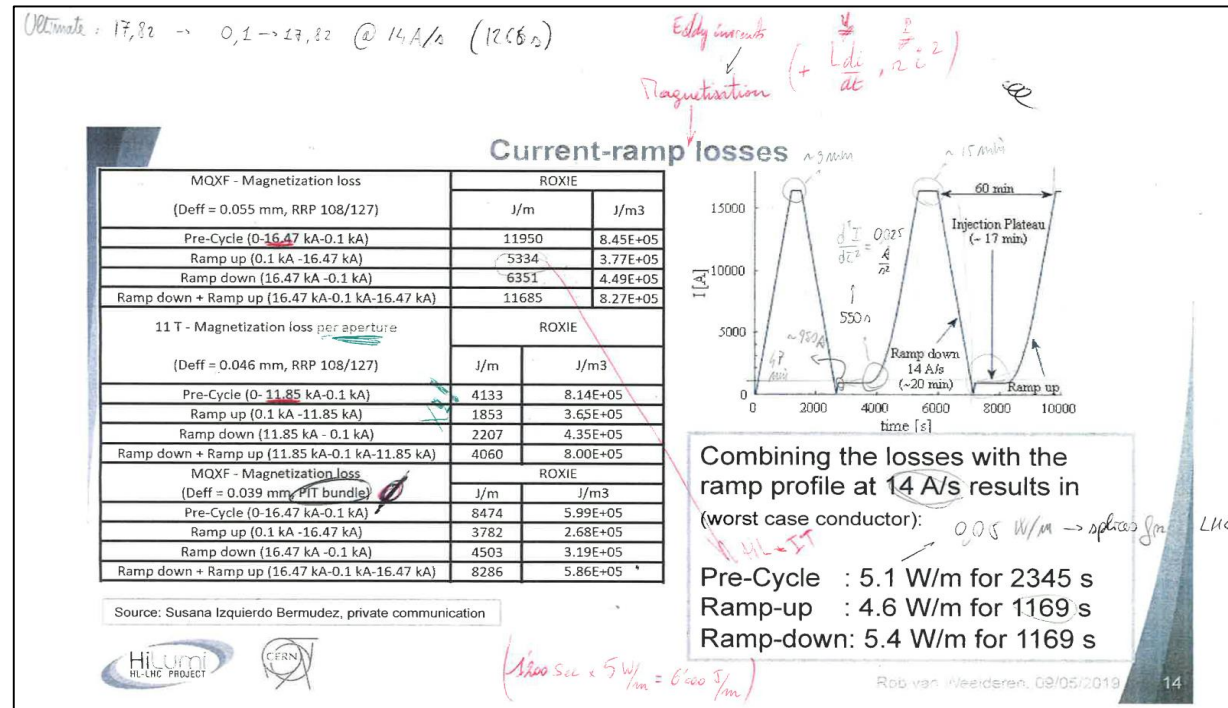


Thanks for your time and answers



Magnetization heat loads (explanation of a fill)

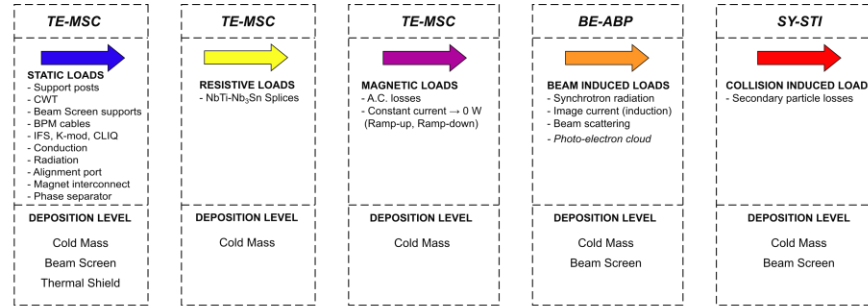
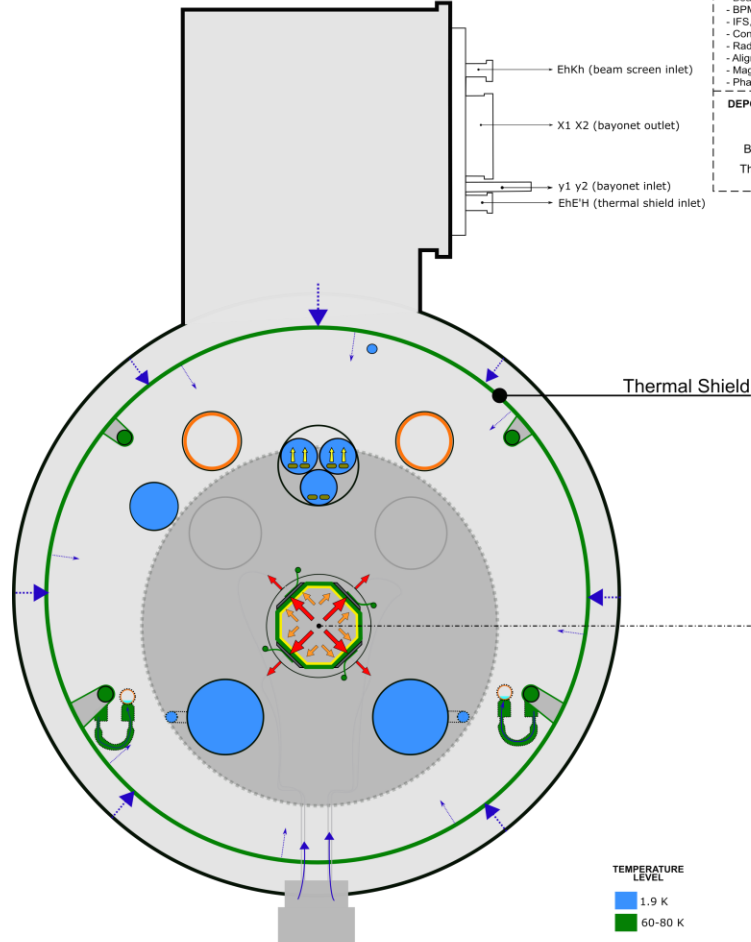
- Heat load due to magnet ramping. Occurs before collision is started and therefore does not impact refrigerator capacity requirement.



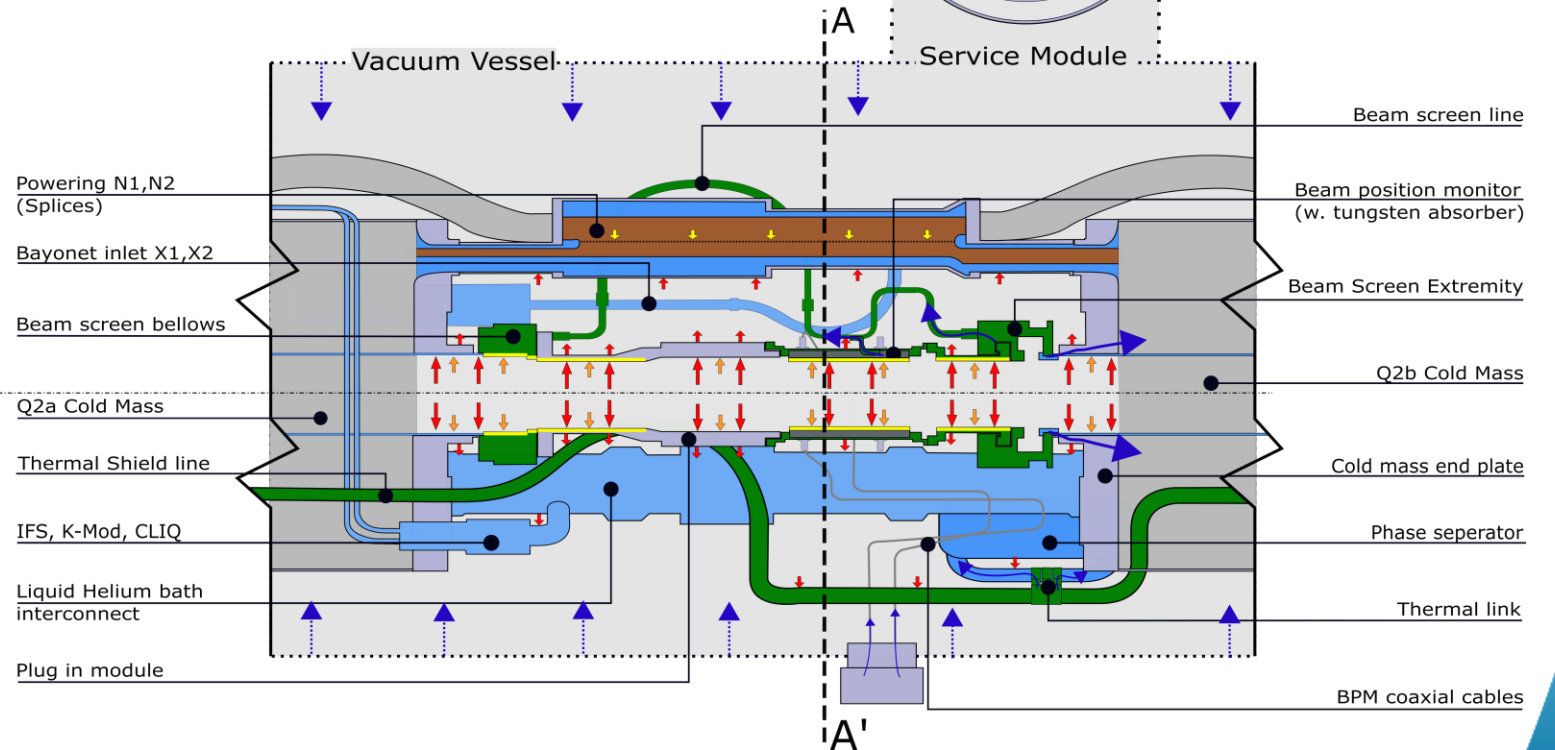
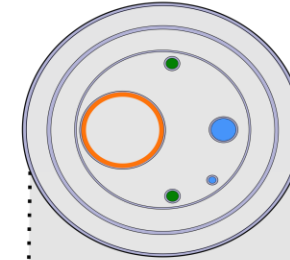
THESE HEAT LOADS ARE ONLY PRESENT EITHER DURING RAMP-UP OR RAMP-DOWN OF THE "Q" MAGNETS (DIPOLES ARE NEGLIGIBLE)

Heat load mechanism in the warm Hilumi interconnect

HEAT LOADS DEPOSITION
HL-LHC INTERCONNECT Q2a-Q2b
CROSS-SECTION A-A'

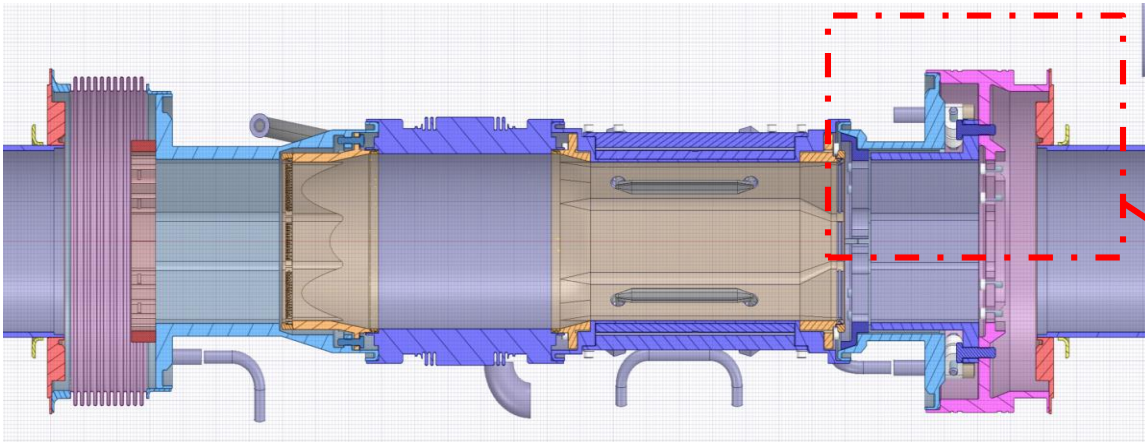


HEAT LOADS DEPOSITION
HL-LHC INTERCONNECT Q2a-Q2b
SIDE VIEW



Particularity of the Hilumi interconnect

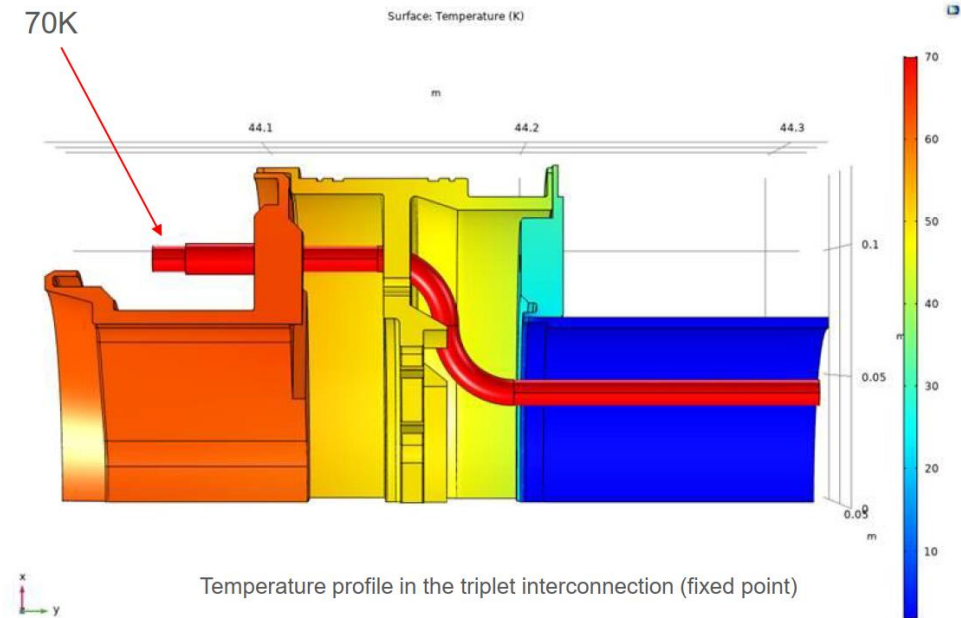
Interconnect between triplet magnets



- Hilumi magnet interconnect temperature is at 60-80 K.
- Particularity for Hilumi
- 5 magnet interconnect result in ~21 W heat load to 1.9 K

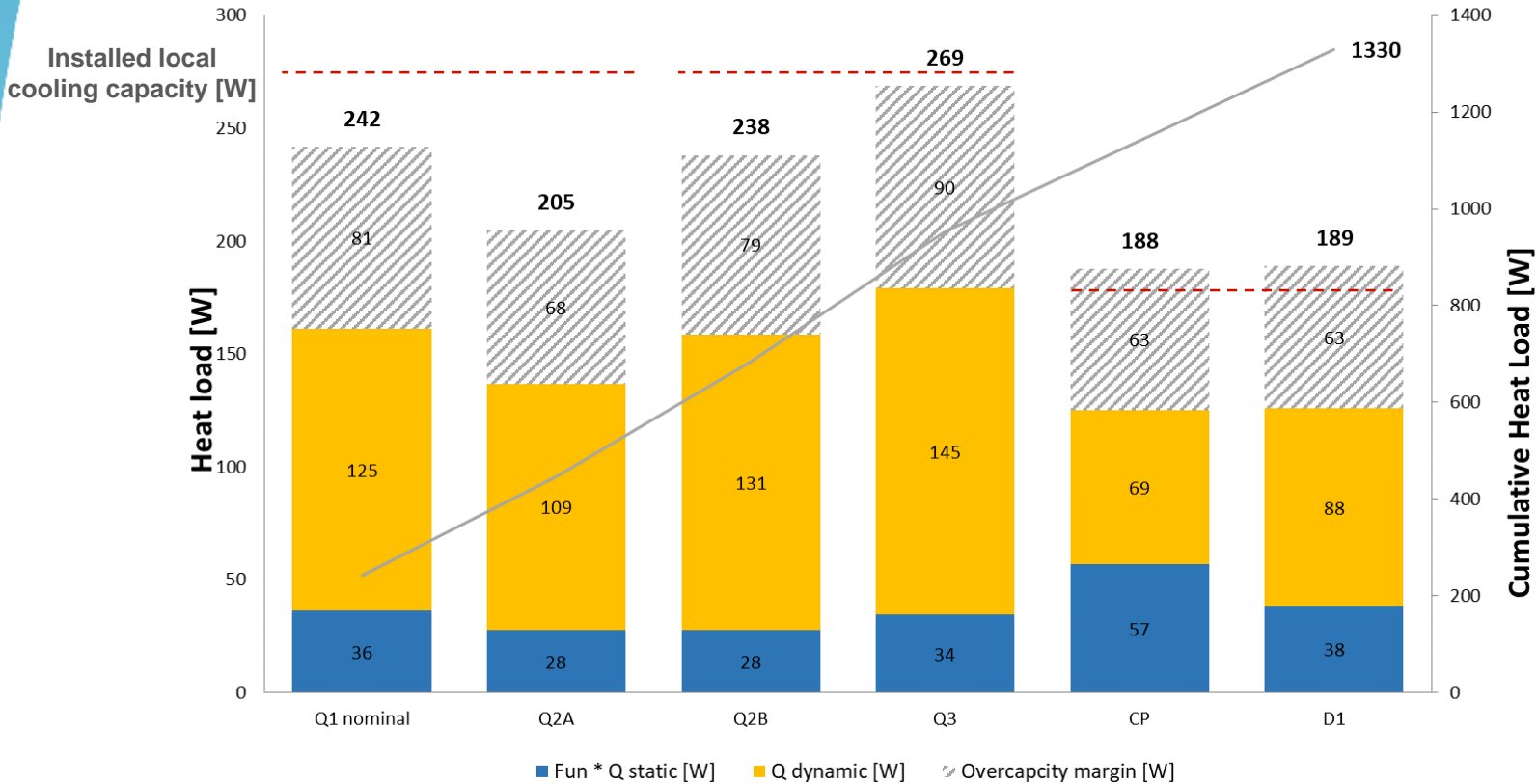
Courtesy C. Garion

Heat load on the 1.9K cold bore



Installed local cooling capacity

Design heat load IT+D1 1.9 K



Heat Load Constrains

Bayonet limit (Dash line)
 ~550 W (for Q1 to Q3 with Ø68mm) and ~350 W (for CP-D1 with Ø54mm)
 → due to flow constrains ($\dot{v} \leq 7 \text{ m/s}$) at each bayonet HX (Line X). (For $\dot{q} \approx 23.3 \text{ W/g}$; $\rho \approx 455 \text{ g/m}^3$)